



DMT32M4LFG

30V N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I⊵ Max Tc = +25°C
	1.7mΩ @ V _{GS} = 10V	100A
30V	2.8mΩ @ V _{GS} = 4.5V	100A

Description

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

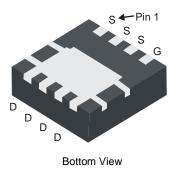
- Low RDS(ON) Ensures On-State Losses Are Minimized
- Excellent Qgd × RDS(ON) Product (FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

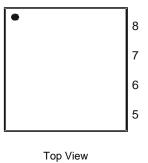
Mechanical Data

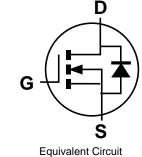
- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed Over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.008 grams (Approximate)



Top View







Ordering Information (Note 4)

B		_
Part Number	Case	Packaging
DMT32M4LFG-7	PowerDI3333-8	2,000/Tape & Reel
DMT32M4LFG-13	PowerDI3333-8	3,000/Tape & Reel

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1

2

3

4

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

PowerDI is a registered trademark of Diodes Incorporated.



Marking Information



SK3 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2
Week	1-26			27-52				53				
Code	A-Z			a-z			Z					
						1		1				
Internal Code	Si	un	Mor	۱ I	Tue		Ned	Thu	I	Fri		Sat
Code	-	Г	U		V		W	Х		Y		Ζ

Maximum Ratings (@ T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	Vdss	30	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$		ID	100 100	A
Continuous Drain Current (Note 6) V _{GS} = 10V	ID	30 24	A	
Maximum Continuous Body Diode Forward Current (Note 5)		ls	2.8	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	Ідм	440	А	
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle	lsм	440	А	
Avalanche Current, L = 0.1mH	las	58	А	
Avalanche Energy, L = 0.1mH	Eas	172	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5) T _A = +25°C		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	115	°C/W	
Total Power Dissipation (Note 6)	PD	2.6	W	
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	49	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	3.9	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad).



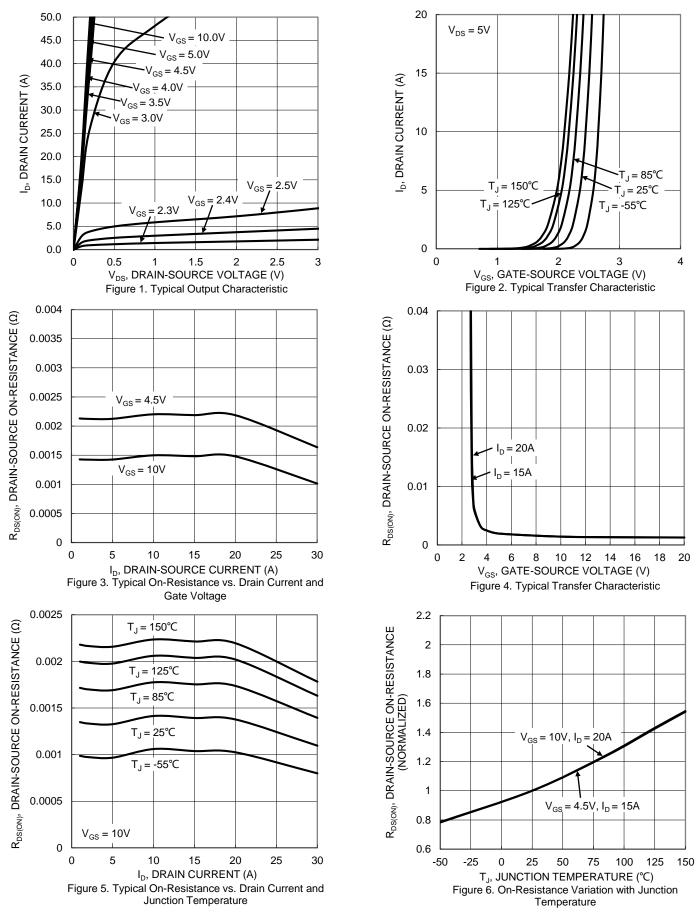
Electrical Characteristics (@T_J = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			•		•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zara Cata Valtaga Drain Current	1	—	—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current	IDSS	_	—	10		$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	lass	_		— ±10		$V_{GS} = 20V, V_{DS} = 0V$	
Gale-Source Leakage	Igss				μA	$V_{GS} = -16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	—	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Descent	_	1.4	1.7	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	Rds(on)	—	2.1	2.8	mΩ	Vgs = 4.5V, ID = 15A	
Diode Forward Voltage	Vsd	—	0.7	1	V	$V_{GS} = 0V, I_S = 2A$	
DYNAMIC CHARACTERISTICS (Note 8)	<u>.</u>						
Input Capacitance	Ciss	_	4366	—		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	_	1568	—	pF		
Reverse Transfer Capacitance	Crss	_	262				
Gate Resistance	Rg	_	0.86	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	33.5				
Total Gate Charge (V _{GS} = 10V)	Qg	_	67				
Gate-Source Charge	Qgs		10.2		nC	$V_{DS} = 15V, I_{D} = 20A$	
Gate-Drain Charge	Q _{gd}	_	12.9				
Turn-On Delay Time	t _{D(ON)}	_	8	_			
Turn-On Rise Time	t _R	—	22	_	1	VDD = 15V, VGS = 10V,	
Turn-Off Delay Time	tD(OFF)	_	48	_	ns	$R_G = 3\Omega$, $I_D = 20A$	
Turn-Off Fall Time	t _F	_	29	_	1		

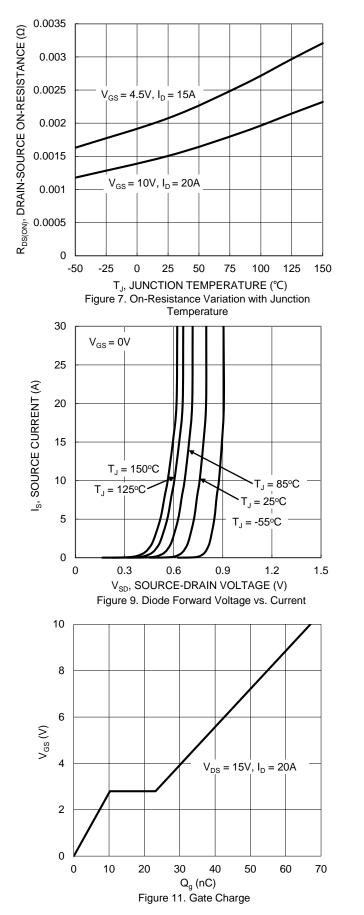
 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing. Notes:



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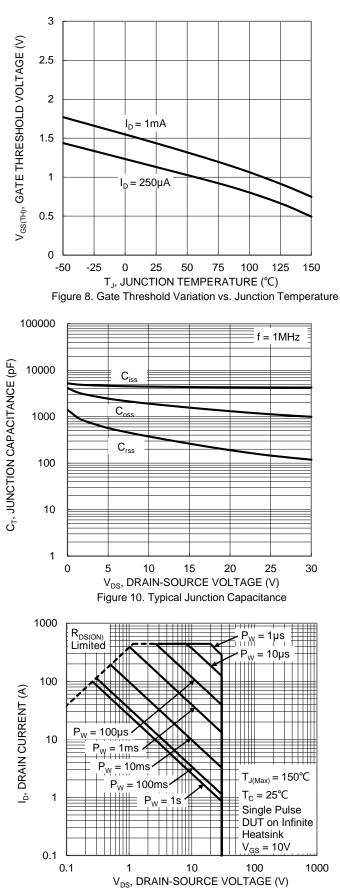
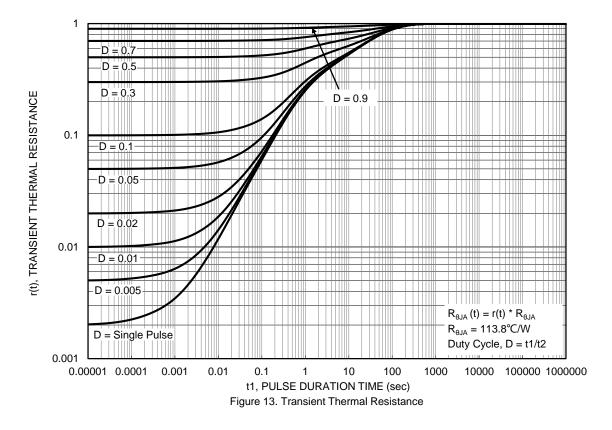


Figure 12. SOA, Safe Operation Area

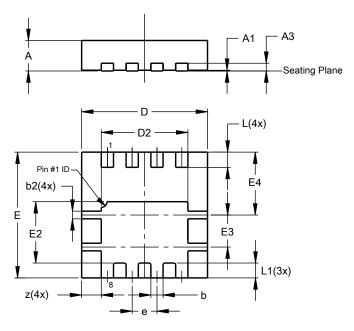






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

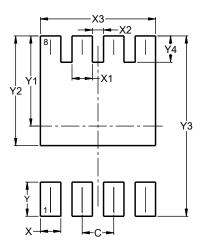


	PowerDI3333-8							
Dim	Min	Max	Тур					
Α	0.75	0.85	0.80					
A1	0.00	0.05	0.02					
A3	-	-	0.203					
b	0.27	0.37	0.32					
b2	0.15	0.25	0.20					
D	3.25	3.35	3.30					
D2	2.22	2.32	2.27					
Е	3.25	3.35	3.30					
E2	1.56	1.66	1.61					
E3	0.79	0.89	0.84					
E4	1.60	1.70	1.65					
e	_	_	0.65					
L	0.35	0.45	0.40					
L1	_	-	0.39					
z	-	-	0.515					
All I	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
X3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540

PowerDI3333-8



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